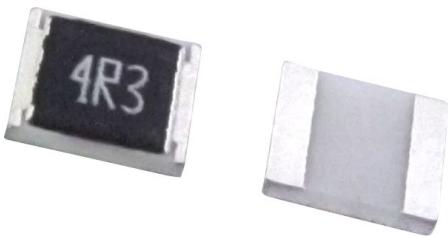


# TSHC

APPLICATION

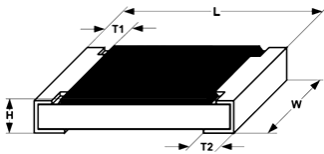
- Entertainment: Stereo, TV tuners, Tape recorder
- Appliance: Air conditioner, Refrigerator
- Computer & relative products : Main board, PDA
- Communication equipment: Cell phone, Fax machine
- Power equipment: Power supply, II illumination equipment
- Measuring instrument: Electric meter, Navigation equipment



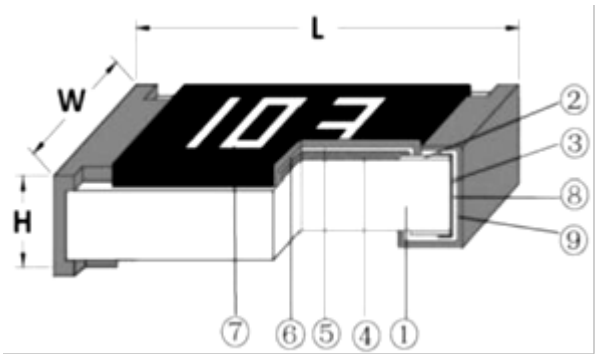
FEATURES

- Small size and light weight
- Reliability, high quality

Dimension

Dimension					
	(unit): mm				
(Type)	L	W	H	T1	T2
1210	3.10±0.10	2.50±0.15	0.55±0.10	0.45±0.15	0.50±0.20
1218	3.10±0.10	4.60±0.10	0.55±0.10	0.45±0.20	0.40±0.20
1812	4.50±0.20	3.10±0.20	0.55±0.10	0.55±0.20	0.70±0.20
2010	5.00±0.10	2.50±0.15	0.55±0.10	0.45±0.15	0.50±0.20
2512	6.35±0.10	3.10±0.15	0.55±0.10	0.60±0.20	0.90±0.20

Construction



NO.	construction	Major material
1	Ceramic substrate	Al <sub>2</sub> O <sub>3</sub>
2	Conductive layer ( Top )	Ag
3	Side conductive layer	Nicr
4	Resistive layer	RuO <sub>2</sub> +glass
5	Inner protective layer	Glass
6	Outer Protective layer	Epoxy
7	Marking	Epoxy
8	Ni plating layer	Ni
9	Sn plating layer	Matte Tin
10	Conductive layer (Back)	Ag

# TSHC

Derating Curve

Temperature usage rang	-55°C~+155°C								
Describe	If the ambient temperature exceeds 70°C to 155°C , the power can be revised according to the curve in the following figure.								
Power Attenuation curve	<p>The graph shows the power attenuation curve for the TSHC resistor. The y-axis represents the Percent rated load (%) from 0 to 100 in increments of 20. The x-axis represents the Ambient temperature (°C) from -55 to 160 in increments of 20. The curve is a horizontal line at 100% load from -55°C to 70°C. At 70°C, the load begins to decrease linearly, reaching 0% at 155°C. The points (70, 100) and (155, 0) are marked on the curve.</p> <table border="1"><caption>Data points for Power Attenuation curve</caption><thead><tr><th>Ambient temperature (°C)</th><th>Percent rated load (%)</th></tr></thead><tbody><tr><td>-55</td><td>100</td></tr><tr><td>70</td><td>100</td></tr><tr><td>155</td><td>0</td></tr></tbody></table>	Ambient temperature (°C)	Percent rated load (%)	-55	100	70	100	155	0
Ambient temperature (°C)	Percent rated load (%)								
-55	100								
70	100								
155	0								

Electrical characteristics

Type	1210	1218	1812	2010	2512
Rated power	1/2W	1W	3/4W	3/4W	1W
Max Working Voltage	200V	200V	200V	200V	200V
Max Overload Voltage	400V	500V	400V	400V	400V
Dielectric Withstanding Voltage	500V	500V	500V	500V	500V
Resistance Value of Jumper ±1%	<30mΩ	<30mΩ	<30mΩ	<30mΩ	<30mΩ
Resistance Value of Jumper ±5%	<50mΩ	<50mΩ	<50mΩ	<50mΩ	<50mΩ
Rated Current of Jumper	2A	6A	2A	2A	2A
Max Current of Jumper	10A	10A	10A	10A	10A

**Remark:** The rated voltage is calculated by the following formula

$E = \sqrt{RP}$

E : Rated Voltage (V)

P : Rated Power (W)

R : Resistance (ohm)

In case the value calculated by the formula exceed the maximum working voltage as above table 8, the maximum working voltage shall be regarded as rated voltage.

# TSHC

## Standard Electrical Specifications

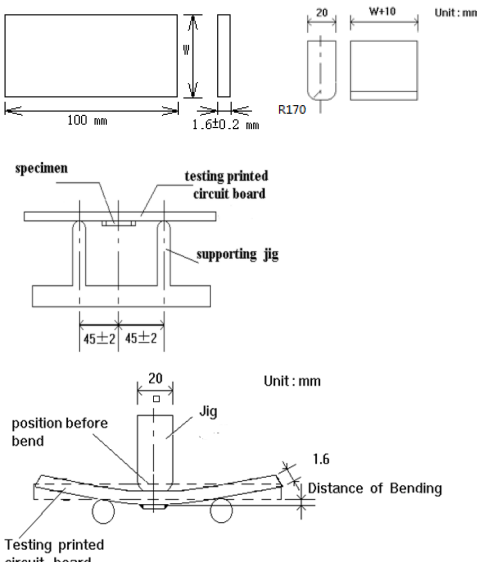
Type	(Power Rating at 70°C)	Max. RCWV	Max. Overload Voltage	T.C.R. (PPM°C)	Resistance Range
1210	1/2W	200V	400V	± 200	1Ω~10Ω
					10MΩ~22MΩ
				± 100	10Ω~10MΩ
1218	1W	200V	500V	± 200	1Ω~10Ω
				± 100	10Ω~1MΩ
1812	3/4W	200V	400V	± 200	1Ω~10Ω
				± 100	10Ω~10MΩ
2010	3/4W	200V	400V	± 200	1Ω~10Ω
					10MΩ~22MΩ
				± 100	10Ω~10MΩ
2512	1W	200V	400V	± 200	1Ω~10Ω
					10MΩ~22MΩ
				± 100	10Ω~10MΩ

## Performance Specifications

Item	Test Methods	Test Conditions	Specification
Temperature Coefficient	JIS C 5201 4.8 IEC60115-1-4.8	TCR= $(R-R_0) / (t-t_0) R_0 \times 10^6$ (ppm) R <sub>0</sub> : Resistance at room temperature R : Resistance at 125°C or -55°C, t <sub>0</sub> : room temperature t : test temperature 125°C or -55°C	As SPEC
Short-time overload	JIS C 5201 4.13 IEC60115-1-4.13	Applied 2.5 times of rated voltage for 5 seconds. Measure the variation of resistance.	0.5%、1%: $\pm(1.0\%+0.05\Omega)$ 5%: $\pm(2.0\%+0.05\Omega)$
Solderability	JIS C 5201 4.17 IEC60115-1-4.17	Dip the terminal in a flux and then dip into a soldering bath at 245±5°C for 3±0.5sec.	> 95% coverage
Resist to soldering heat	JIS C 5201 4.18 IEC 60115-1-4.18	Dip the terminal in a flux and then dip into a soldering bath at 260±5°C for 10±0.5sec. Measure the variation of resistance.	$\pm (1.00\% + 0.05\Omega)$
Insulation resistance	JIS C 5201 4.6 IEC60115-1-4.6	Applied the dielectric withstanding voltage on the center of body for 60±5seconds. Then measure insulation resistance.	>10GΩ

# TSHC

## Performance Specifications

Item	Test Methods	Test Conditions	Specification
Dielectric withstanding voltage	JIS C 5201 4.7 IEC60115-1-4.7	Applied the dielectric withstanding voltage on the center of body for $60 \pm 5$ seconds.	No evidence of flashover, mechanical damage arcing or insulation breakdown
Terminal bending	JIS C 5201 4.33 IEC60115-1-4.33	<p>Specimen shall be mounted on test board, then bend the board and maintained for <math>20 \pm 1</math> s. the distance of bending is <math>5 + 0.2/0</math> mm for resistors which size no larger than 1206 or <math>2 + 0.2/0</math> mm which size larger than 1206. Measure the variation of resistance.</p> <p>(test board) (jig)</p> 	$\pm (1.00\% + 0.05\Omega)$
Rapid temperature changes	JIS C 5201 4.19 IEC60115-1-4.19	<p>Put specimen in a chamber which temperature can be</p> <p>T1: <math>-55 \pm 3^\circ\text{C}</math>;</p> <p>T2: <math>155 \pm 3^\circ\text{C}/125 \pm 3^\circ\text{C}</math>, 30min, repeated 300 cycles.</p> <p>Measure the variation of resistance.</p>	<p>0.5%、1%: <math>\pm(1.0\% + 0.05\Omega)</math></p> <p>5%: <math>\pm(2.0\% + 0.05\Omega)</math></p>
Humidity	JIS C 5201 4.24 IEC60115-1-4.24	<p>Put the specimen in a chamber at <math>40 \pm 2^\circ\text{C}</math> temperature and 90~95% relative humidity, then applied rated voltage for 1.5H and rested for 0.5H repeatedly till total test time is <math>1000^{+48}_{-0}</math> H. Measure the variation of resistance.</p>	<p>0.5%、1%: <math>\pm(1.0\% + 0.05\Omega)</math></p> <p>5%: <math>\pm(2.0\% + 0.05\Omega)</math></p>

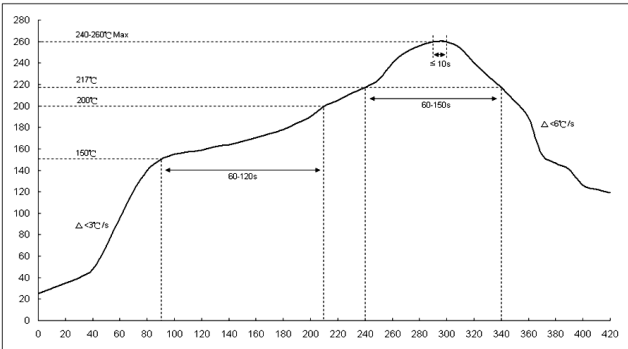
# TSHC

Performance Specifications

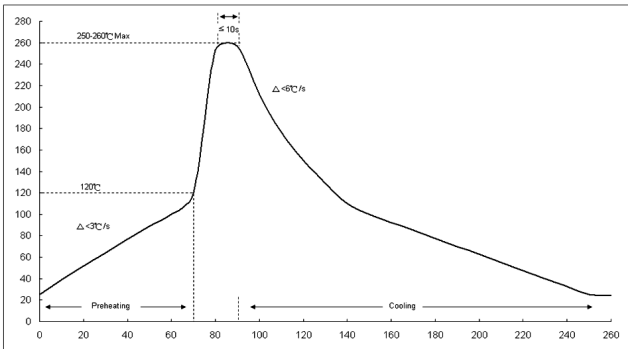
Item	Test Methods	Test Conditions	Specification
Load life	JIS C 5201 4.25.1 IEC 60115-1-4.25.1	Put the specimen in a chamber at 70±2°C temperature, ON TIME:1.5H, OFF TIME:0.5H, and applied rated voltage for 1000 <sup>+24</sup> / <sub>-0</sub> H. Measure the variation of resistance.	0.5%、1%: ±(1.0%+0.05Ω) 5%: ±(2.0%+0.05Ω)
Moisture resistance	MIL-STD-202 METHOD 106	25°C~65°C, 90~100%RH, 2.5H; 65°C 90~100%RH, 3H; 65°C~25°C 80~100%RH, 2.5H, 10 cycles, Measurement at 24±4 hours after test conclusion.	0.5%、1%: ±(1.0%+0.05Ω) 5%: ±(2.0%+0.05Ω)

Soldering

Recommend reflow soldering profile



Recommend wave soldering profile



Hand soldering temperature

The iron temperature is 350±10°C, hand soldering time less than 3S. Avoid solder iron tip direct touch the components body

Note: Specifications are subject to change without notice. For more detail and update, please visit our website